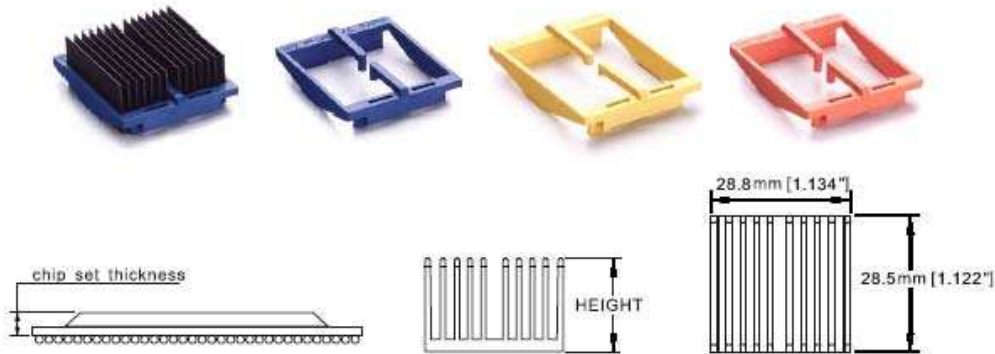


Specification BGA Heat Sink for 29x29 chip set



<p>■ Heat sink material : AL6063</p> <p>■ Finish : Black Anodize</p> <p>■ Chip set package thickness and clip color : 2.1mm~2.6mm ----- Yellow clip 1.5mm~2.0mm ----- Blue clip 0.9mm~1.4mm ----- Orange clip</p> <p>■ Accessory : Clip material ----- Plastic(94V0) Thermal pad ----- T725 27x27mm [1.063"]</p>	Part number	Length (mm) [Inch]	Width (mm) [Inch]	Total height (mm) [Inch]	Base (mm) [Inch]	Clip color
	CMS312929-06-01	28.8 [1.134"]	28.7 [1.129"]	6.3 [0.248"]	1.7 [0.066"]	Yellow
	CMS312929-06-02					Blue
	CMS312929-06-03					Orange
	CMS312929-10-01	28.8 [1.134"]	28.5 [1.122"]	9.5 [0.374"]	1.7 [0.066"]	Yellow
	CMS312929-10-02					Blue
	CMS312929-10-03					Orange
	CMS312929-13-01	28.8 [1.134"]	28.5 [1.122"]	12.7 [0.500"]	1.7 [0.066"]	Yellow
	CMS312929-13-02					Blue
	CMS312929-13-03					Orange

Performance Heat Source(LxW):15x15mm

